## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:		)	
	Rahul N. Manepalli et al.	Examiner: Not yet assigned	
		) Art Unit:	Not yet assigned
Serial No.:	Not yet assigned	)	, ,
Filed:	Herewith	)	
MOLDED M	DERFILLING PROCESS IN A ATRIX ARRAY PACKAGE USING NT MODIFYING SOLDER RESIST	/	
Which is a Divisional of Application of: )			
Serial No:	10/287,318	) )	
Filed:	November 4, 2002	<u>í</u>	
Commission	er for Patents		
P.O. Box 14	50		
ا Alexandria. ۱	VA 22313-1450		

## **PRELIMINARY AMENDMENT**

Sir:

Applicants respectfully request that this Preliminary Amendment be entered prior to examination of the above-identified patent application.

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